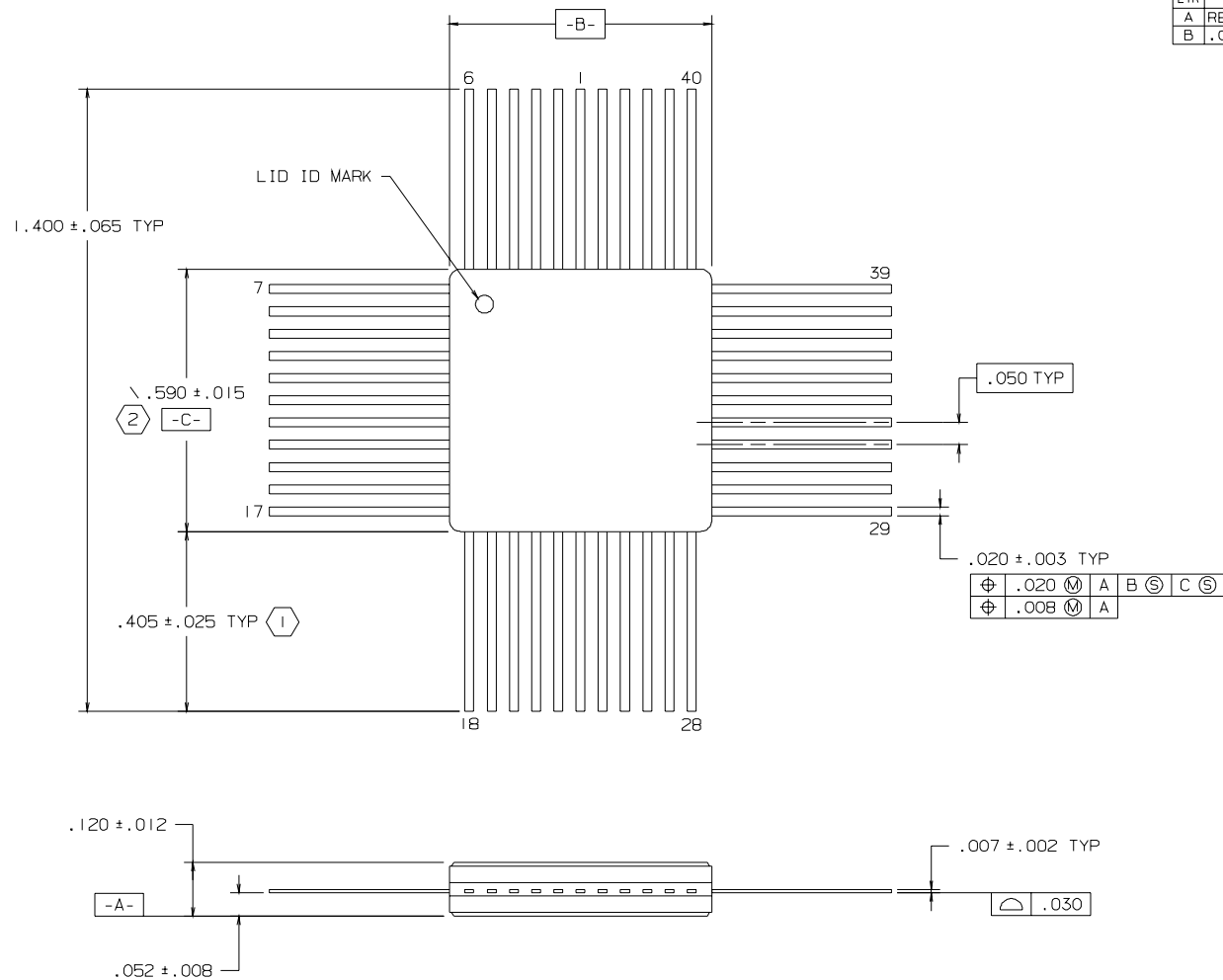


R E V I S I O N S				
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
A	RELEASE TO DOCUMENT CONTROL	09351	10/08/92	MS/SL
B	.065 WAS .035 & .025 WAS .010	09946	08/11/93	DEG/



NOTES: UNLESS OTHERWISE SPECIFIED

1. LEADFRAME TO BE SOLDER DIPPED 200 MICROINCHES/ 5.08 MICROMETERS MINIMUM, MEASURED AT CREST OF THE MAJOR FLATS.
2. DIMENSION INCLUDES THE OFFSET OF BASE AND LID.
3. NO JEDEC REGISTRATION AS OF 09/08/92.

MIL/AERO
CONFIGURATION CONTROL

DIMENSIONS ARE IN INCHES				
APPROVALS	DATE	 NATIONAL SEMICONDUCTOR CORPORATION 2900 Semiconductor Drive, Santa Clara, CA 95052-8090		
DRAWN MARTA SUCHY	10/08/92			
DFTG. CHK.				
ENGR. CHK.				
APPROVAL				
 PROJECTION INCH [MM]		SCALE N/A	SIZE C	DRAWING NUMBER MKT-WA44A
		DO NOT SCALE DRAWING	SHEET	OF

CERQUAD, 44 LEAD,
STRAIGHT

REV
B